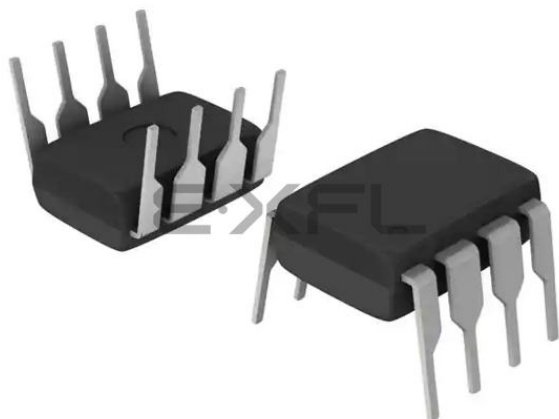




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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	5
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 4x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	8-DIP (0.300", 7.62mm)
Supplier Device Package	8-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic12lf1501-i-p

TABLE 1-2: PIC12(L)F1501 PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0/AN0/C1IN+/DACOUT1/ CWG1B ⁽¹⁾ /CLC2IN1/PWM2/ ICSPDAT	RA0	TTL	CMOS	General purpose I/O.
	AN0	AN	—	A/D Channel input.
	C1IN+	AN	—	Comparator positive input.
	DACOUT1	—	AN	Digital-to-Analog Converter output.
	CWG1B	—	CMOS	CWG complementary output.
	CLC2IN1	ST	—	Configurable Logic Cell source input.
	PWM2	—	CMOS	Pulse Width Module source output.
	ICSPDAT	ST	CMOS	ICSP™ Data I/O.
RA1/AN1/VREF+/C1IN0-/ NCO1 ⁽¹⁾ /CLC2IN0/ICSPCLK	RA1	TTL	CMOS	General purpose I/O.
	AN1	AN	—	A/D Channel input.
	VREF+	AN	—	A/D Positive Voltage Reference input.
	C1IN0-	AN	—	Comparator negative input.
	NCO1	—	CMOS	Numerically Controlled Oscillator output.
	CLC2IN0	ST	—	Configurable Logic Cell source input.
	ICSPCLK	ST	—	ICSP™ Programming Clock.
RA2/AN2/C1OUT/DACOUT2/ T0CKI/INT/PWM1/CLC1 ⁽¹⁾ / CWG1A ⁽¹⁾ /CWG1FLT	RA2	ST	CMOS	General purpose I/O.
	AN2	AN	—	A/D Channel input.
	C1OUT	—	CMOS	Comparator output.
	DACOUT2	—	AN	Digital-to-Analog Converter output.
	T0CKI	ST	—	Timer0 clock input.
	INT	ST	—	External interrupt.
	PWM1	—	CMOS	Pulse Width Module source output.
	CLC1	—	CMOS	Configurable Logic Cell source output.
	CWG1A	—	CMOS	CWG complementary output.
RA3/CLC1IN0/VPP/T1G ⁽¹⁾ /MCLR	RA3	TTL	—	General purpose input.
	CLC1IN0	ST	—	Configurable Logic Cell source input.
	VPP	HV	—	Programming voltage.
	T1G	ST	—	Timer1 Gate input.
	MCLR	ST	—	Master Clear with internal pull-up.
RA4/AN3/C1IN1-/CWG1B ⁽¹⁾ / CLC1 ⁽¹⁾ /PWM3/CLKOUT/T1G ⁽¹⁾	RA4	TTL	CMOS	General purpose I/O.
	AN3	AN	—	A/D Channel input.
	C1IN1-	AN	—	Comparator negative input.
	CWG1B	—	CMOS	CWG complementary output.
	CLC1	—	CMOS	Configurable Logic Cell source output.
	PWM3	—	CMOS	Pulse Width Module source output.
	CLKOUT	—	CMOS	Fosc/4 output.
	T1G	ST	—	Timer1 Gate input.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I²C™ = Schmitt Trigger input with I²C levels
HV = High Voltage XTAL = Crystal

Note 1: Alternate pin function selected with the APFCON (Register 11-1) register.

2.0 ENHANCED MID-RANGE CPU

This family of devices contain an enhanced mid-range 8-bit CPU core. The CPU has 49 instructions. Interrupt capability includes automatic context saving. The hardware stack is 16 levels deep and has Overflow and Underflow Reset capability. Direct, Indirect, and Relative addressing modes are available. Two File Select Registers (FSRs) provide the ability to read program and data memory.

- Automatic Interrupt Context Saving
- 16-level Stack with Overflow and Underflow
- File Select Registers
- Instruction Set

FIGURE 2-1: CORE BLOCK DIAGRAM

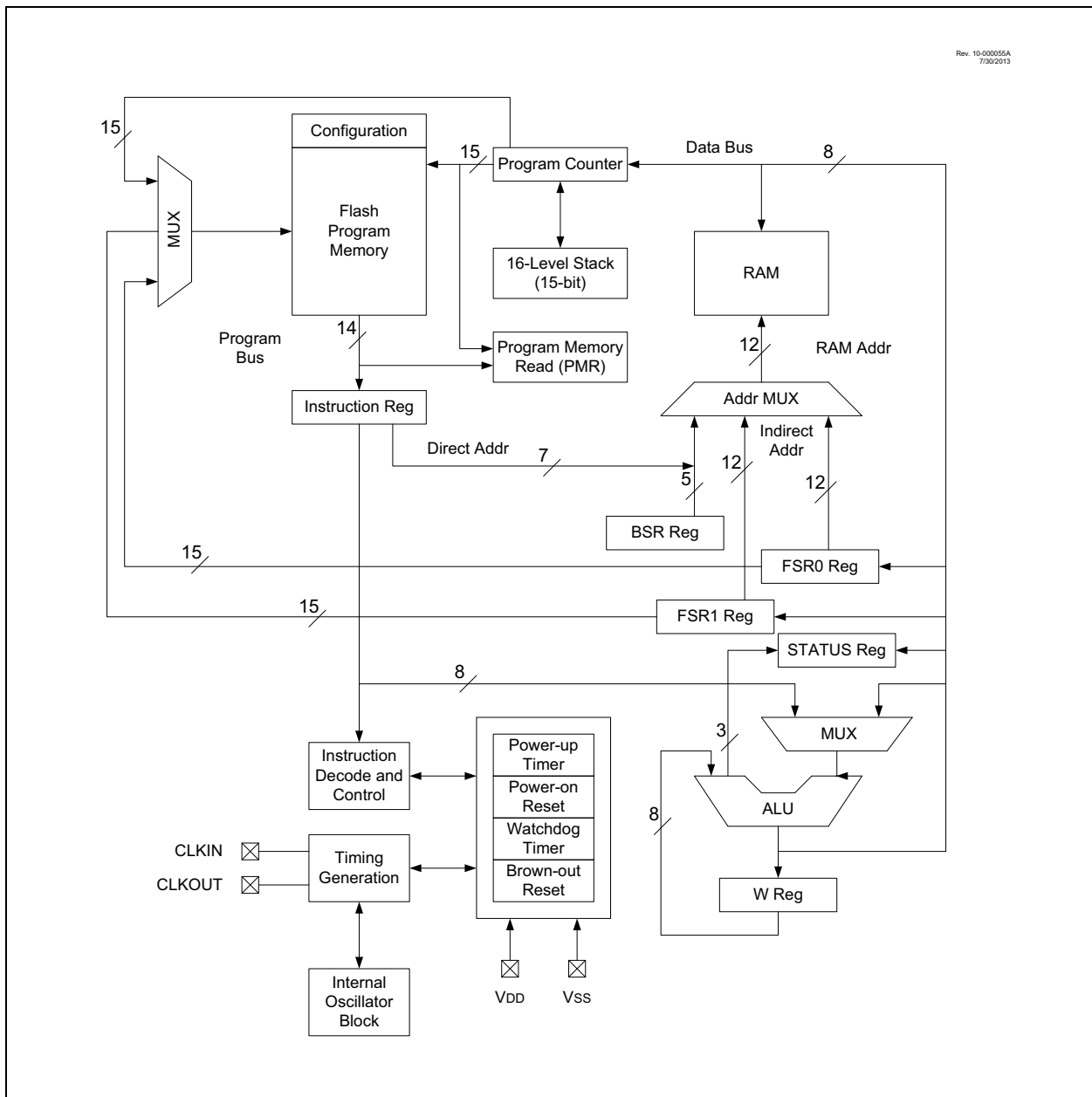


TABLE 3-3: PIC12(L)F1501 MEMORY MAP (CONTINUED)

BANK 24		BANK 25		BANK 26		BANK 27		BANK 28		BANK 29		BANK 30		BANK 31	
C00h	Core Registers (Table 3-2)	C80h	Core Registers (Table 3-2)	D00h	Core Registers (Table 3-2)	D80h	Core Registers (Table 3-2)	E00h	Core Registers (Table 3-2)	E80h	Core Registers (Table 3-2)	F00h	Core Registers (Table 3-2)	F80h	Core Registers (Table 3-2)
C0Bh		C8Bh		D0Bh		D8Bh		E0Bh		E8Bh		F0Bh		F8Bh	
C0Ch	—	C8Ch	—	D0Ch	—	D8Ch	—	E0Ch	—	E8Ch	—	F0Ch	See Table 3-3 for register mapping details	F8Ch	See Table 3-3 for register mapping details
C0Dh	—	C8Dh	—	D0Dh	—	D8Dh	—	E0Dh	—	E8Dh	—	F0Dh		F8Dh	
C0Eh	—	C8Eh	—	D0Eh	—	D8Eh	—	E0Eh	—	E8Eh	—	F0Eh		F8Eh	
C0Fh	—	C8Fh	—	D0Fh	—	D8Fh	—	E0Fh	—	E8Fh	—	F0Fh		F8Fh	
C10h	—	C90h	—	D10h	—	D90h	—	E10h	—	E90h	—	F10h		F90h	
C11h	—	C91h	—	D11h	—	D91h	—	E11h	—	E91h	—	F11h		F91h	
C12h	—	C92h	—	D12h	—	D92h	—	E12h	—	E92h	—	F12h		F92h	
C13h	—	C93h	—	D13h	—	D93h	—	E13h	—	E93h	—	F13h		F93h	
C14h	—	C94h	—	D14h	—	D94h	—	E14h	—	E94h	—	F14h		F94h	
C15h	—	C95h	—	D15h	—	D95h	—	E15h	—	E95h	—	F15h		F95h	
C16h	—	C96h	—	D16h	—	D96h	—	E16h	—	E96h	—	F16h		F96h	
C17h	—	C97h	—	D17h	—	D97h	—	E17h	—	E97h	—	F17h		F97h	
C18h	—	C98h	—	D18h	—	D98h	—	E18h	—	E98h	—	F18h		F98h	
C19h	—	C99h	—	D19h	—	D99h	—	E19h	—	E99h	—	F19h		F99h	
C1Ah	—	C9Ah	—	D1Ah	—	D9Ah	—	E1Ah	—	E9Ah	—	F1Ah		F9Ah	
C1Bh	—	C9Bh	—	D1Bh	—	D9Bh	—	E1Bh	—	E9Bh	—	F1Bh		F9Bh	
C1Ch	—	C9Ch	—	D1Ch	—	D9Ch	—	E1Ch	—	E9Ch	—	F1Ch		F9Ch	
C1Dh	—	C9Dh	—	D1Dh	—	D9Dh	—	E1Dh	—	E9Dh	—	F1Dh		F9Dh	
C1Eh	—	C9Eh	—	D1Eh	—	D9Eh	—	E1Eh	—	E9Eh	—	F1Eh		F9Eh	
C1Fh	—	C9Fh	—	D1Fh	—	D9Fh	—	E1Fh	—	E9Fh	—	F1Fh		F9Fh	
C20h	Unimplemented Read as '0'	CA0h	Unimplemented Read as '0'	D20h	Unimplemented Read as '0'	DA0h	Unimplemented Read as '0'	E20h	Unimplemented Read as '0'	EA0h	Unimplemented Read as '0'	F20h	Common RAM (Accesses 70h – 7Fh)	FA0h	Common RAM (Accesses 70h – 7Fh)
C6Fh	Common RAM (Accesses 70h – 7Fh)	CEFh	Common RAM (Accesses 70h – 7Fh)	D6Fh	Common RAM (Accesses 70h – 7Fh)	DEFh	Common RAM (Accesses 70h – 7Fh)	E6Fh	Common RAM (Accesses 70h – 7Fh)	EEFh	Common RAM (Accesses 70h – 7Fh)	F6Fh		FEFh	
C70h		CF0h		D70h		DF0h		E70h		EF0h		F70h		FF0h	
CFFh		CFFh		D7Fh		DFh		E7Fh		EFFh		F7Fh		FFFh	

Legend: = Unimplemented data memory locations, read as '0'.

3.3.6 CORE FUNCTION REGISTERS SUMMARY

The Core Function registers listed in Table 3-4 can be addressed from any Bank.

TABLE 3-4: CORE FUNCTION REGISTERS SUMMARY

Addr	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets	
Bank 0-31												
x00h or x80h	INDF0	Addressing this location uses contents of FSR0H/FSR0L to address data memory (not a physical register)								xxxx xxxx	uuuu uuuu	
x01h or x81h	INDF1	Addressing this location uses contents of FSR1H/FSR1L to address data memory (not a physical register)								xxxx xxxx	uuuu uuuu	
x02h or x82h	PCL	Program Counter (PC) Least Significant Byte								0000 0000	0000 0000	
x03h or x83h	STATUS	—	—	—	$\overline{TO}$	$\overline{PD}$	Z	DC	C	---1 1000	---q quuu	
x04h or x84h	FSR0L	Indirect Data Memory Address 0 Low Pointer								0000 0000	uuuu uuuu	
x05h or x85h	FSR0H	Indirect Data Memory Address 0 High Pointer								0000 0000	0000 0000	
x06h or x86h	FSR1L	Indirect Data Memory Address 1 Low Pointer								0000 0000	uuuu uuuu	
x07h or x87h	FSR1H	Indirect Data Memory Address 1 High Pointer								0000 0000	0000 0000	
x08h or x88h	BSR	—	—	—	BSR<4:0>					---0 0000	---0 0000	
x09h or x89h	WREG	Working Register								0000 0000	uuuu uuuu	
x0Ah or x8Ah	PCLATH	—	Write Buffer for the upper 7 bits of the Program Counter								-000 0000	-000 0000
x0Bh or x8Bh	INTCON	GIE	PEIE	TMR0IE	INTE	IOCFE	TMR0IF	INTF	IOCF	0000 0000	0000 0000	

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, read as '0', r = reserved.
Shaded locations are unimplemented, read as '0'.

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TABLE 3-5: SPECIAL FUNCTION REGISTER SUMMARY (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
Bank 10											
50Ch to 51Fh	—	Unimplemented								—	—
Bank 11											
58Ch to 59Fh	—	Unimplemented								—	—
Bank 12											
60Ch to 610h	—	Unimplemented								—	—
611h	PWM1DCL	PWM1DCL<7:6>		—	—	—	—	—	—	00-- ----	00-- ----
612h	PWM1DCH	PWM1DCH<7:0>								xxxx xxxx	uuuu uuuu
613h	PWM1CON0	PWM1EN	PWM1OE	PWM1OUT	PWM1POL	—	—	—	—	0000 ----	0000 ----
614h	PWM2DCL	PWM2DCL<7:6>		—	—	—	—	—	—	00-- ----	00-- ----
615h	PWM2DCH	PWM2DCH<7:0>								xxxx xxxx	uuuu uuuu
616h	PWM2CON0	PWM2EN	PWM2OE	PWM2OUT	PWM2POL	—	—	—	—	0000 ----	0000 ----
617h	PWM3DCL	PWM3DCL<7:6>		—	—	—	—	—	—	00-- ----	00-- ----
618h	PWM3DCH	PWM3DCH<7:0>								xxxx xxxx	uuuu uuuu
619h	PWM3CON0	PWM3EN	PWM3OE	PWM3OUT	PWM3POL	—	—	—	—	0000 ----	0000 ----
61Ah	PWM4DCL	PWM4DCL<7:6>		—	—	—	—	—	—	00-- ----	00-- ----
61Bh	PWM4DCH	PWM4DCH<7:0>								xxxx xxxx	uuuu uuuu
61Ch	PWM4CON0	PWM4EN	PWM4OE	PWM4OUT	PWM4POL	—	—	—	—	0000 ----	0000 ----
61Dh to 61Fh	—	Unimplemented								—	—
Bank 13											
68Ch to 690h	—	Unimplemented								—	—
691h	CWG1DBR	—	—	CWG1DBR<5:0>						--00 0000	--00 0000
692h	CWG1DBF	—	—	CWG1DBF<5:0>						--xx xxxx	--xx xxxx
693h	CWG1CON0	G1EN	G1OEB	G1OEA	G1POLB	G1POLA	—	—	G1CS0	0000 0--0	0000 0--0
694h	CWG1CON1	G1ASDLB<1:0>		G1ASDLA<1:0>		—	G1IS<2:0>			0000 -000	0000 -000
695h	CWG1CON2	G1ASE	G1ARSEN	—	—	—	G1ASDSC1	G1ASDSFLT	G1ASDSCLC2	00-- -000	00-- -000
696h to 69Fh	—	Unimplemented								—	—

Legend: x = unknown, u = unchanged, q = value depends on condition, - = unimplemented, r = reserved. Shaded locations are unimplemented, read as '0'.

- Note** 1: PIC12F1501 only.
2: Unimplemented, read as '1'.

4.0 DEVICE CONFIGURATION

Device configuration consists of Configuration Words, Code Protection and Device ID.

4.1 Configuration Words

There are several Configuration Word bits that allow different oscillator and memory protection options. These are implemented as Configuration Word 1 at 8007h and Configuration Word 2 at 8008h.

Note: The $\overline{\text{DEBUG}}$ bit in Configuration Words is managed automatically by device development tools including debuggers and programmers. For normal device operation, this bit should be maintained as a '1'.
--

6.13 Power Control (PCON) Register

The Power Control (PCON) register contains flag bits to differentiate between a:

- Power-on Reset ($\overline{\text{POR}}$)
- Brown-out Reset ($\overline{\text{BOR}}$)
- Reset Instruction Reset ($\overline{\text{RI}}$)
- $\overline{\text{MCLR}}$ Reset ($\overline{\text{RMCLR}}$)
- Watchdog Timer Reset ($\overline{\text{RWDT}}$)
- Stack Underflow Reset (STKUNF)
- Stack Overflow Reset (STKOVF)

The PCON register bits are shown in Register 6-2.

6.14 Register Definitions: Power Control

REGISTER 6-2: PCON: POWER CONTROL REGISTER

R/W/HS-0/q	R/W/HS-0/q	U-0	R/W/HC-1/q	R/W/HC-1/q	R/W/HC-1/q	R/W/HC-q/u	R/W/HC-q/u
STKOVF	STKUNF	—	$\overline{\text{RWDT}}$	$\overline{\text{RMCLR}}$	$\overline{\text{RI}}$	$\overline{\text{POR}}$	$\overline{\text{BOR}}$
bit 7							bit 0

Legend:

HC = Bit is cleared by hardware

HS = Bit is set by hardware

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

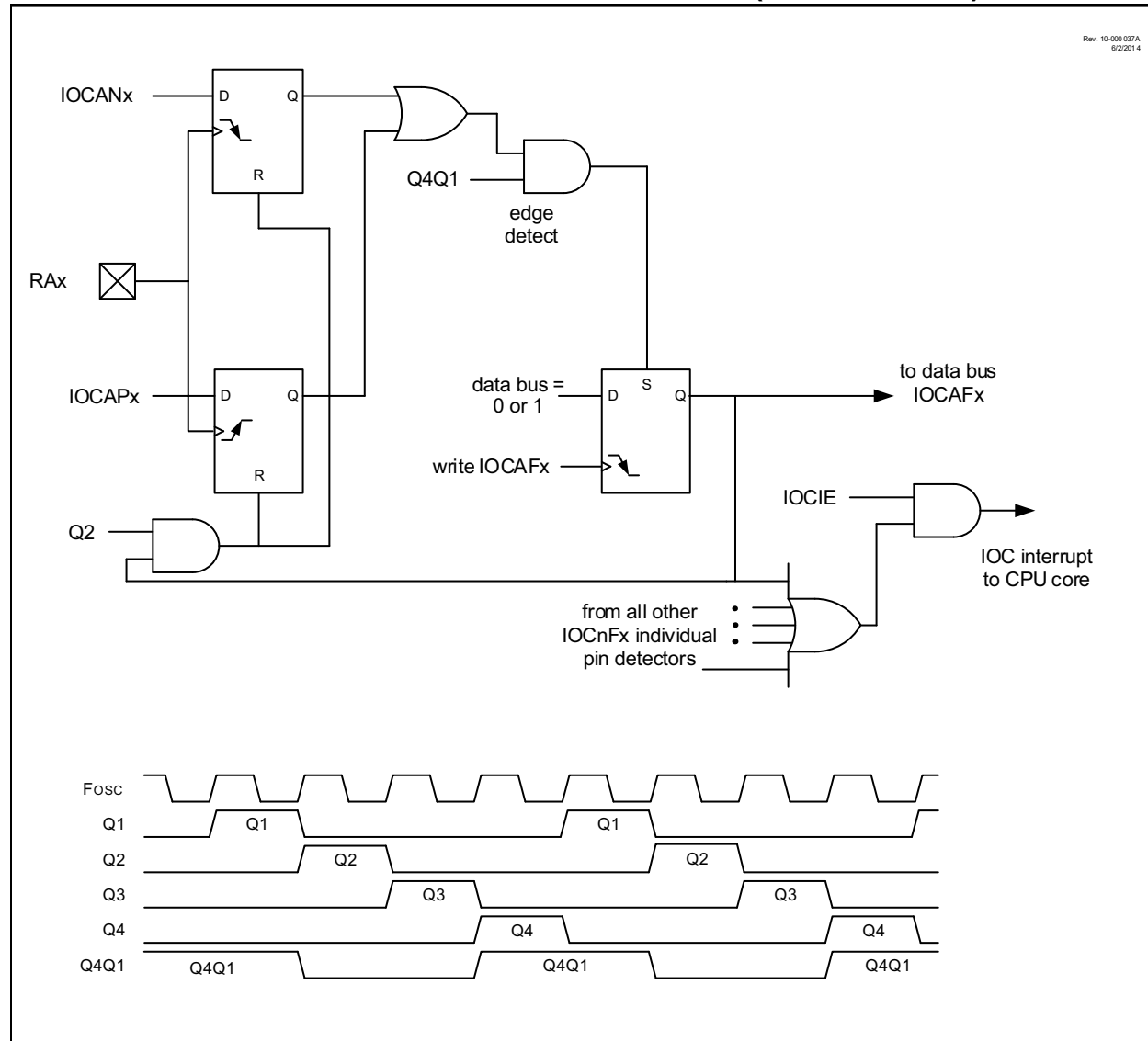
'0' = Bit is cleared

q = Value depends on condition

bit 7	STKOVF: Stack Overflow Flag bit 1 = A Stack Overflow occurred 0 = A Stack Overflow has not occurred or cleared by firmware
bit 6	STKUNF: Stack Underflow Flag bit 1 = A Stack Underflow occurred 0 = A Stack Underflow has not occurred or cleared by firmware
bit 5	Unimplemented: Read as '0'
bit 4	$\overline{\text{RWDT}}$: Watchdog Timer Reset Flag bit 1 = A Watchdog Timer Reset has not occurred or set by firmware 0 = A Watchdog Timer Reset has occurred (cleared by hardware)
bit 3	$\overline{\text{RMCLR}}$: $\overline{\text{MCLR}}$ Reset Flag bit 1 = A $\overline{\text{MCLR}}$ Reset has not occurred or set by firmware 0 = A $\overline{\text{MCLR}}$ Reset has occurred (cleared by hardware)
bit 2	$\overline{\text{RI}}$: RESET Instruction Flag bit 1 = A RESET instruction has not been executed or set by firmware 0 = A RESET instruction has been executed (cleared by hardware)
bit 1	$\overline{\text{POR}}$: Power-On Reset Status bit 1 = No Power-on Reset occurred 0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs)
bit 0	$\overline{\text{BOR}}$: Brown-Out Reset Status bit 1 = No Brown-out Reset occurred 0 = A Brown-out Reset occurred (must be set in software after a Power-on Reset or Brown-out Reset occurs)

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FIGURE 12-1: INTERRUPT-ON-CHANGE BLOCK DIAGRAM (PORTA EXAMPLE)



PIC12(L)F1501

15.3 Register Definitions: ADC Control

REGISTER 15-1: ADCON0: ADC CONTROL REGISTER 0

U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	CHS<4:0>					GO/DONE	ADON
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7 **Unimplemented:** Read as '0'

bit 6-2 **CHS<4:0>:** Analog Channel Select bits

00000 = AN0

00001 = AN1

00010 = AN2

00011 = AN3

00100 = Reserved. No channel connected.

•

•

•

11100 = Reserved. No channel connected.

11101 = Temperature Indicator⁽¹⁾

11110 = DAC (Digital-to-Analog Converter)⁽³⁾

11111 = FVR (Fixed Voltage Reference) Buffer 1 Output⁽²⁾

bit 1 **GO/DONE:** ADC Conversion Status bit

1 = ADC conversion cycle in progress. Setting this bit starts an ADC conversion cycle.

This bit is automatically cleared by hardware when the ADC conversion has completed.

0 = ADC conversion completed/not in progress

bit 0 **ADON:** ADC Enable bit

1 = ADC is enabled

0 = ADC is disabled and consumes no operating current

Note 1: See Section 14.0 "Temperature Indicator Module" for more information.

2: See Section 13.0 "Fixed Voltage Reference (FVR)" for more information.

3: See Section 16.0 "5-Bit Digital-to-Analog Converter (DAC) Module" for more information.

PIC12(L)F1501

REGISTER 15-6: ADRESH: ADC RESULT REGISTER HIGH (ADRESH) ADFM = 1

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	—	—	—	—	ADRES<9:8>	
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-2 **Reserved:** Do not use.

bit 1-0 **ADRES<9:8>:** ADC Result Register bits
Upper two bits of 10-bit conversion result

REGISTER 15-7: ADRESL: ADC RESULT REGISTER LOW (ADRESL) ADFM = 1

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
ADRES<7:0>							
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-0 **ADRES<7:0>:** ADC Result Register bits
Lower eight bits of 10-bit conversion result

PIC12(L)F1501

22.1 CLCx Setup

Programming the CLCx module is performed by configuring the four stages in the logic signal flow. The four stages are:

- Data selection
- Data gating
- Logic function selection
- Output polarity

Each stage is setup at run time by writing to the corresponding CLCx Special Function Registers. This has the added advantage of permitting logic reconfiguration on-the-fly during program execution.

22.1.1 DATA SELECTION

There are 16 signals available as inputs to the configurable logic. Four 8-input multiplexers are used to select the inputs to pass on to the next stage. The 16 inputs to the multiplexers are arranged in groups of four. Each group is available to two of the four multiplexers, in

each case, paired with a different group. This arrangement makes possible selection of up to two from a group without precluding a selection from another group.

Data selection is through four multiplexers as indicated on the left side of Figure 22-2. Data inputs in the figure are identified by a generic numbered input name.

Table 22-1 correlates the generic input name to the actual signal for each CLC module. The columns labeled lcx1 through lcx4 indicate the MUX output for the selected data input. D1S through D4S are abbreviations for the MUX select input codes: LCxD1S<2:0> through LCxD4S<2:0>, respectively. Selecting a data input in a column excludes all other inputs in that column.

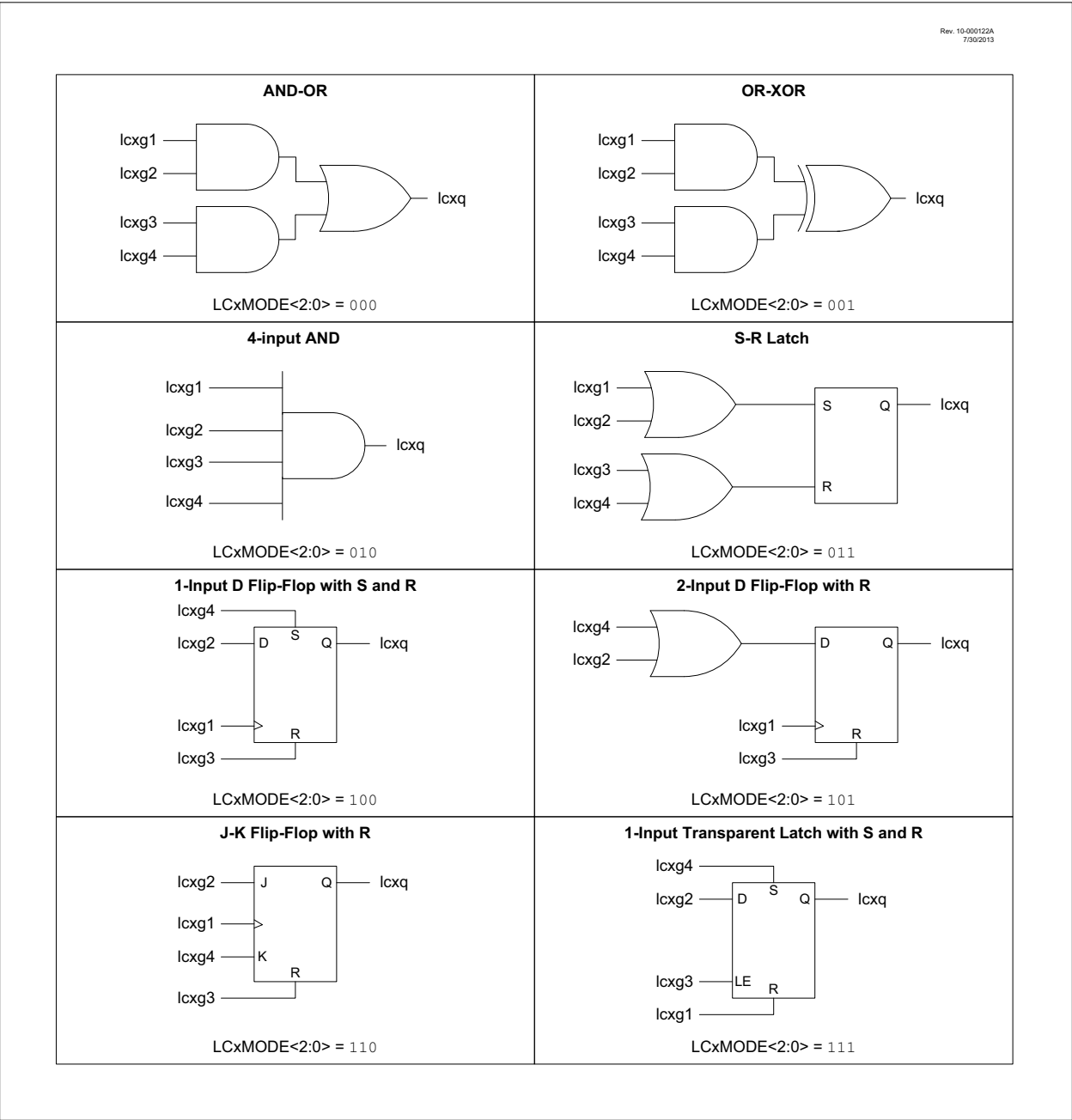
Data inputs are selected with CLCxSEL0 and CLCxSEL1 registers (Register 22-3 and Register 22-5, respectively).

Note: Data selections are undefined at power-up.

TABLE 22-1: CLCx DATA INPUT SELECTION

Data Input	lcxd1 D1S	lcxd2 D2S	lcxd3 D3S	lcxd4 D4S	CLC 1	CLC 2
LCx_in[0]	000	—	—	100	CLC1IN0	CLC2IN0
LCx_in[1]	001	—	—	101	CLC1IN1	CLC2IN1
LCx_in[2]	010	—	—	110	C1OUT_sync	C1OUT_sync
LCx_in[3]	011	—	—	111	Reserved	Reserved
LCx_in[4]	100	000	—	—	Fosc	Fosc
LCx_in[5]	101	001	—	—	T0_overflow	T0_overflow
LCx_in[6]	110	010	—	—	T1_overflow	T1_overflow
LCx_in[7]	111	011	—	—	T2_match	T2_match
LCx_in[8]	—	100	000	—	LC1_out	LC1_out
LCx_in[9]	—	101	001	—	LC2_out	LC2_out
LCx_in[10]	—	110	010	—	Reserved	Reserved
LCx_in[11]	—	111	011	—	Reserved	Reserved
LCx_in[12]	—	—	100	000	NCO1_out	LFINTOSC
LCx_in[13]	—	—	101	001	HFINTOSC	FRC
LCx_in[14]	—	—	110	010	PWM3_out	PWM1_out
LCx_in[15]	—	—	111	011	PWM4_out	PWM2_out

FIGURE 22-3: PROGRAMMABLE LOGIC FUNCTIONS



PIC12(L)F1501

REGISTER 22-2: CLCxPOL: SIGNAL POLARITY CONTROL REGISTER

R/W-0/0	U-0	U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
LCxPOL	—	—	—	LCxG4POL	LCxG3POL	LCxG2POL	LCxG1POL
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

- bit 7 **LCxPOL:** LCOOUT Polarity Control bit
1 = The output of the logic cell is inverted
0 = The output of the logic cell is not inverted
- bit 6-4 **Unimplemented:** Read as '0'
- bit 3 **LCxG4POL:** Gate 4 Output Polarity Control bit
1 = The output of gate 4 is inverted when applied to the logic cell
0 = The output of gate 4 is not inverted
- bit 2 **LCxG3POL:** Gate 3 Output Polarity Control bit
1 = The output of gate 3 is inverted when applied to the logic cell
0 = The output of gate 3 is not inverted
- bit 1 **LCxG2POL:** Gate 2 Output Polarity Control bit
1 = The output of gate 2 is inverted when applied to the logic cell
0 = The output of gate 2 is not inverted
- bit 0 **LCxG1POL:** Gate 1 Output Polarity Control bit
1 = The output of gate 1 is inverted when applied to the logic cell
0 = The output of gate 1 is not inverted

REGISTER 22-9: CLCDATA: CLC DATA OUTPUT

U-0	U-0	U-0	U-0	U-0	U-0	R-0	R-0
—	—	—	—	—	—	MLC2OUT	MLC1OUT
bit 7						bit 0	

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-2 Unimplemented: Read as '0'

bit 1 MLC2OUT: Mirror copy of LC2OUT bit

bit 0 MLC1OUT: Mirror copy of LC1OUT bit

REGISTER 23-6: NCOxINCL: NCOx INCREMENT REGISTER – LOW BYTE⁽¹⁾

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-1/1
NCOxINC<7:0>							
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **NCOxINC<7:0>**: NCOx Increment, Low Byte

Note 1: Write the NCOxINCH register first, then the NCOxINCL register. See **23.1.4 “Increment Registers”** for more information.

REGISTER 23-7: NCOxINCH: NCOx INCREMENT REGISTER – HIGH BYTE⁽¹⁾

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
NCOxINC<15:8>							
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **NCOxINC<15:8>**: NCOx Increment, High Byte

Note 1: Write the NCOxINCH register first, then the NCOxINCL register. See **23.1.4 “Increment Registers”** for more information.

TABLE 23-1: SUMMARY OF REGISTERS ASSOCIATED WITH NCOx

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
APFCON	CWG1BSEL	CWGA1SEL	—	—	T1GSEL	—	CLC1SEL	NCO1SEL	96
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	64
NCO1ACCH	NCO1ACC<15:8>								178
NCO1ACCL	NCO1ACC<7:0>								178
NCO1ACCU	—				NCO1ACC<19:16>				178
NCO1CLK	N1PWS<2:0>			—	—	—	N1CKS<1:0>		177
NCO1CON	N1EN	N1OE	N1OUT	N1POL	—	—	—	N1PFM	177
NCO1INCH	NCO1INC<15:8>								179
NCO1INCL	NCO1INC<7:0>								179
PIE2	—	—	C1IE	—	—	NCO1IE	—	—	66
PIR2	—	—	C1IF	—	—	NCO1IF	—	—	69
TRISA	—	—	TRISA5	TRISA4	— ⁽¹⁾	TRISA2	TRISA1	TRISA0	98

Legend: x = unknown, u = unchanged, — = unimplemented read as '0', q = value depends on condition. Shaded cells are not used for NCOx module.

Note 1: Unimplemented, read as '1'.

FIGURE 27-7: CLKOUT AND I/O TIMING

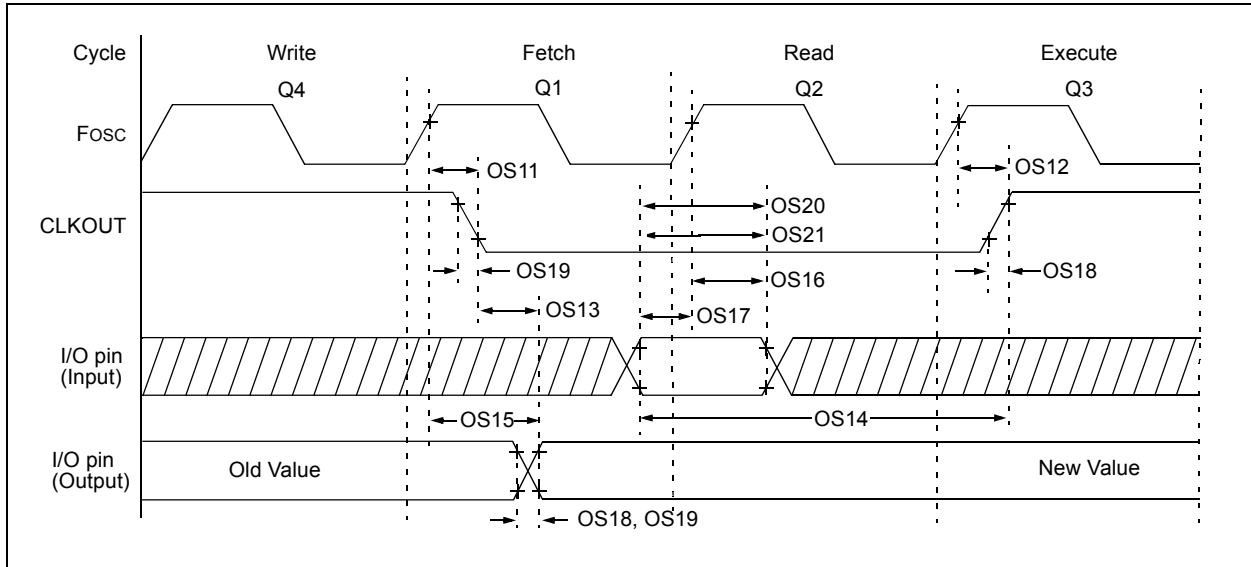


TABLE 27-9: CLKOUT AND I/O TIMING PARAMETERS

Standard Operating Conditions (unless otherwise stated)							
Param. No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
OS11	TosH2ckL	Fosc↑ to CLKOUT↓ ⁽¹⁾	—	—	70	ns	3.3V ≤ VDD ≤ 5.0V
OS12	TosH2ckH	Fosc↑ to CLKOUT↑ ⁽¹⁾	—	—	72	ns	3.3V ≤ VDD ≤ 5.0V
OS13	TckL2ioV	CLKOUT↓ to Port out valid ⁽¹⁾	—	—	20	ns	
OS14	TioV2ckH	Port input valid before CLKOUT↑ ⁽¹⁾	Tosc + 200 ns	—	—	ns	
OS15	TosH2ioV	Fosc↑ (Q1 cycle) to Port out valid	—	50	70*	ns	3.3V ≤ VDD ≤ 5.0V
OS16	TosH2ioI	Fosc↑ (Q2 cycle) to Port input invalid (I/O in setup time)	50	—	—	ns	3.3V ≤ VDD ≤ 5.0V
OS17	TioV2osH	Port input valid to Fosc↑ (Q2 cycle) (I/O in setup time)	20	—	—	ns	
OS18*	TioR	Port output rise time	—	40 15	72 32	ns	VDD = 1.8V 3.3V ≤ VDD ≤ 5.0V
OS19*	TioF	Port output fall time	—	28 15	55 30	ns	VDD = 1.8V 3.3V ≤ VDD ≤ 5.0V
OS20*	Tinp	INT pin input high or low time	25	—	—	ns	
OS21*	Tioc	Interrupt-on-change new input level time	25	—	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated.

Note 1: Measurements are taken in EXTRC mode where CLKOUT output is 4 x Tosc.

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FIGURE 27-10: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

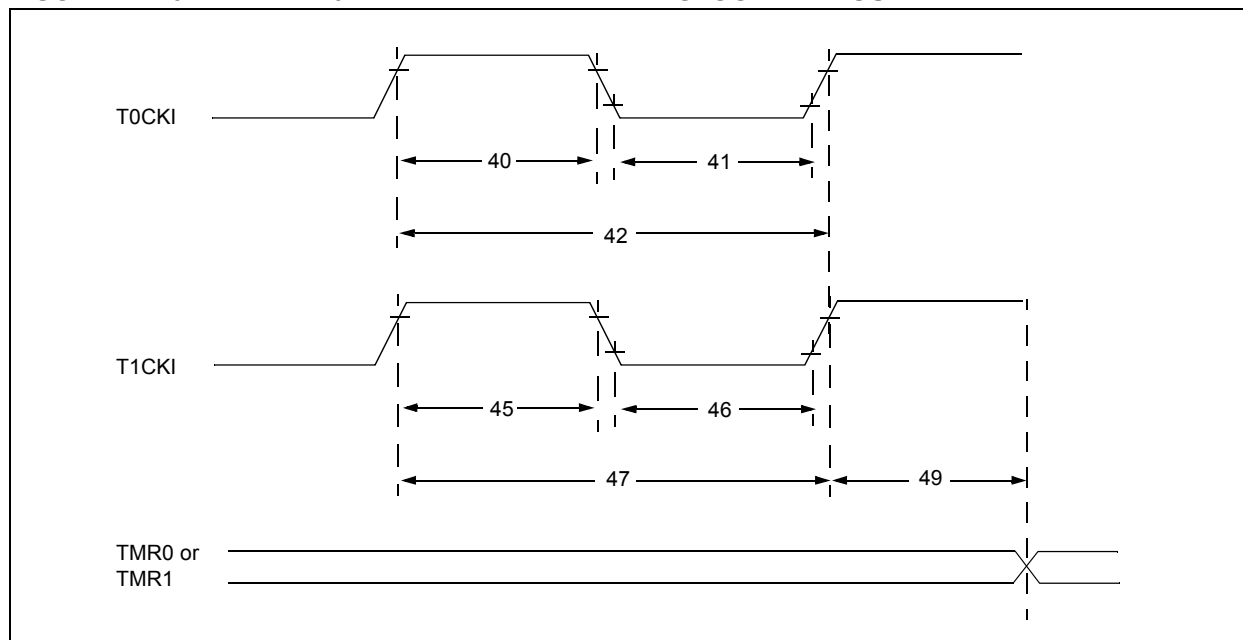


TABLE 27-11: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Standard Operating Conditions (unless otherwise stated)								
Param. No.	Sym.	Characteristic		Min.	Typ†	Max.	Units	Conditions
40*	Tt0H	T0CKI High Pulse Width	No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			With Prescaler	10	—	—	ns	
41*	Tt0L	T0CKI Low Pulse Width	No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			With Prescaler	10	—	—	ns	
42*	Tt0P	T0CKI Period		Greater of: 20 or $\frac{T_{CY} + 40}{N}$	—	—	ns	N = prescale value
45*	Tt1H	T1CKI High Time	Synchronous, No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			Synchronous, with Prescaler	15	—	—	ns	
			Asynchronous	30	—	—	ns	
46*	Tt1L	T1CKI Low Time	Synchronous, No Prescaler	$0.5 T_{CY} + 20$	—	—	ns	
			Synchronous, with Prescaler	15	—	—	ns	
			Asynchronous	30	—	—	ns	
47*	Tt1P	T1CKI Input Period	Synchronous	Greater of: 30 or $\frac{T_{CY} + 40}{N}$	—	—	ns	N = prescale value
			Asynchronous	60	—	—	ns	
49*	TCKEZTMR1	Delay from External Clock Edge to Timer Increment		$2 T_{OSC}$	—	$7 T_{OSC}$	—	Timers in Sync mode

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 28-25: I_{PD}, FIXED VOLTAGE REFERENCE (FVR), PIC12LF1501 ONLY

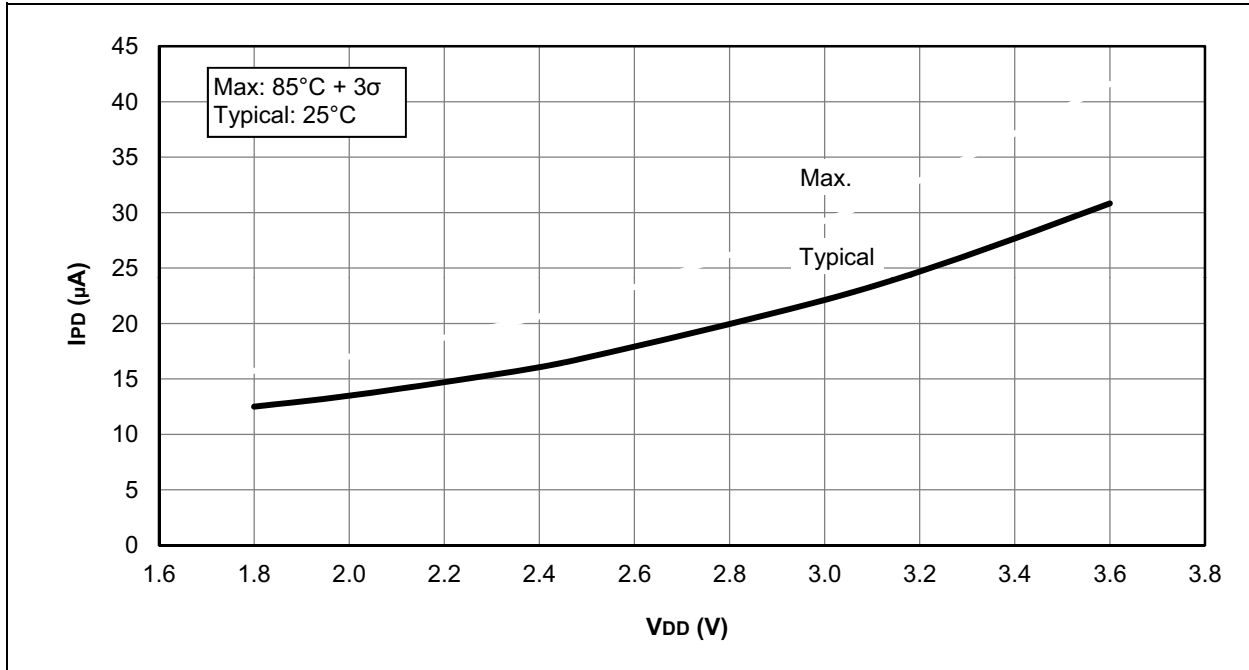


FIGURE 28-26: I_{PD}, FIXED VOLTAGE REFERENCE (FVR), PIC12F1501 ONLY

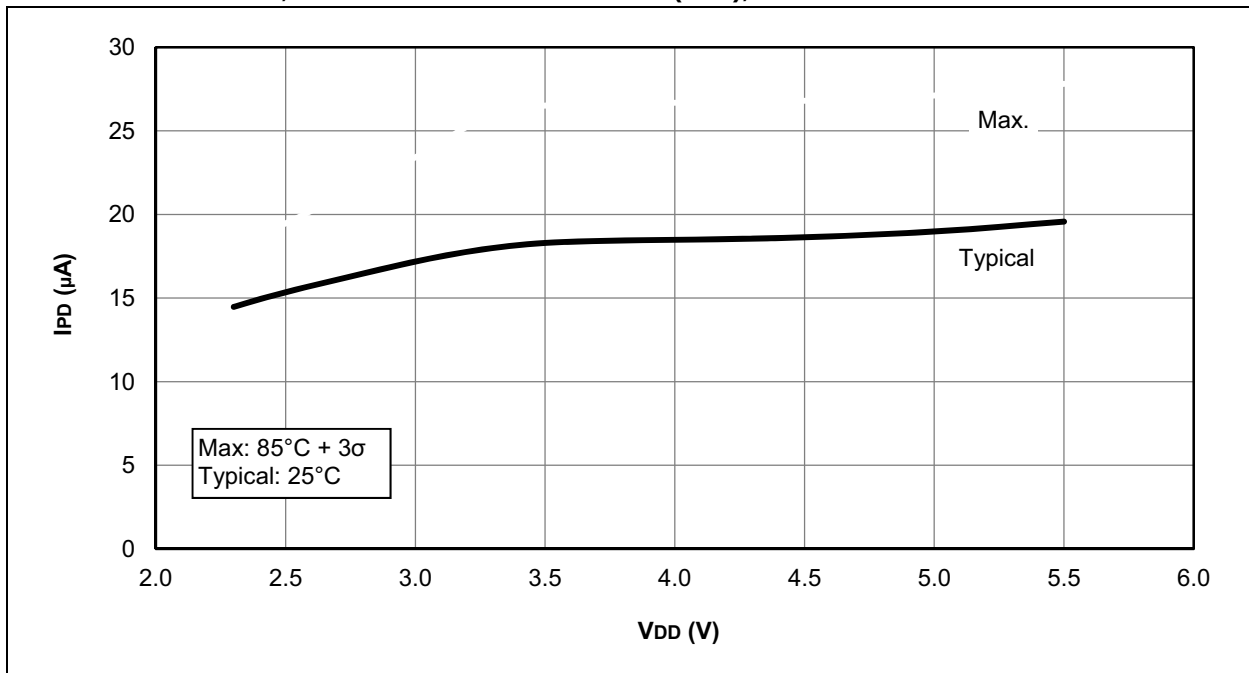


TABLE 30-1: 8-LEAD 2x3 DFN (MC) TOP MARKING

Part Number	Marking
PIC12F1501-E/MC	BAK
PIC12F1501-I/MC	BAL
PIC12LF1501-E/MC	BAM
PIC12LF1501-I/MC	BAP

TABLE 30-2: 8-LEAD 3x3 DFN (MF) TOP MARKING

Part Number	Marking
PIC12F1501-E/MF	MFA1
PIC12F1501-I/MF	MFB1
PIC12LF1501-E/MF	MFC1
PIC12LF1501-I/MF	MFD1

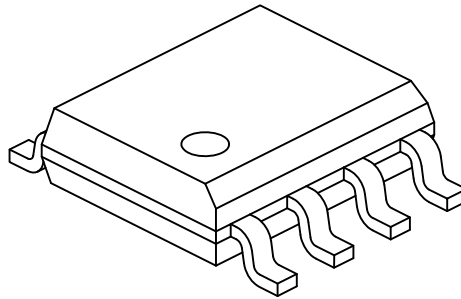
TABLE 30-3: 8-LEAD 2X3 UDFN (MU) TOP MARKING

Part Number	Marking
PIC12F1501-E/MU	BAR
PIC12F1501-I/MU	BAQ
PIC12LF1501-E/MU	BAT
PIC12LF1501-I/MU	BAS

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8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packages>



		Units	MILLIMETERS		
Dimension Limits			MIN	NOM	MAX
Number of Pins	N		8		
Pitch	e		1.27 BSC		
Overall Height	A		-	-	1.75
Molded Package Thickness	A2		1.25	-	-
Standoff §	A1		0.10	-	0.25
Overall Width	E		6.00 BSC		
Molded Package Width	E1		3.90 BSC		
Overall Length	D		4.90 BSC		
Chamfer (Optional)	h		0.25	-	0.50
Foot Length	L		0.40	-	1.27
Footprint	L1		1.04 REF		
Foot Angle	φ		0°	-	8°
Lead Thickness	c		0.17	-	0.25
Lead Width	b		0.31	-	0.51
Mold Draft Angle Top	α		5°	-	15°
Mold Draft Angle Bottom	β		5°	-	15°

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
- Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-057C Sheet 2 of 2